

**AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

Serial Number: 09/652,430

Filing Date: August 31, 2000

Title: ELECTRONIC ASSEMBLY COMPRISING SOLDERABLE THERMAL INTERFACE (As Amended)

Assignee: Intel Corporation

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Dkt: 884.319US1 (INTEL)

**IN THE SPECIFICATION**

Please make the paragraph substitutions indicated below. The specific changes incorporated in the substitute paragraphs are shown in the following marked-up versions of the original paragraphs.

The sub-title on page 3, line 11 is amended as follows:

**Detailed Description of Embodiments of the Invention**

The paragraph beginning on page 3, line 13 is amended as follows:

In the following detailed description of embodiments of the invention, reference is made to the accompanying drawings which form a part hereof, and in which is shown by way of illustration specific preferred embodiments in which the subject matter may be practiced. These embodiments are described in sufficient detail to enable those skilled in the art to practice them, and it is to be understood that other embodiments may be utilized and that logical, mechanical, and electrical changes may be made without departing from the spirit and scope of the present disclosure. Such embodiments of the inventive subject matter may be referred to, individually and/or collectively, herein by the term "invention" merely for convenience and without intending to voluntarily limit the scope of this application to any single invention or inventive concept if more than one is in fact disclosed. The following detailed description is, therefore, not to be taken in a limiting sense, and the scope of the present disclosure is defined only by the appended claims.

Please delete the sub-title "Conclusion" on page 12, line 1: Conclusion